

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

|  |   |         |
|--|---|---------|
| Title of Invention   | SYSTEM FOR FABRICATING AN INTEGRATED CIRCUIT PACKAGE ON A PRINTED CIRCUIT BOARD |         |
| Application Type: regular, utility   |   |         |
| Correspondence address:  |   |         |
| Customer Number:   | 22898   | *22898* |
| Continuing Data:   |   |         |
| This is a Non-Provisional of US application number 60/465,432, filed 2003-04-25. |   |         |
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

**Publication Information:**

**Suggested Figure for Publication – FIG. 1**

**Suggested Classification –**

**Suggested Technology Center –**

**Total Number of Drawing Sheets – 3**

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